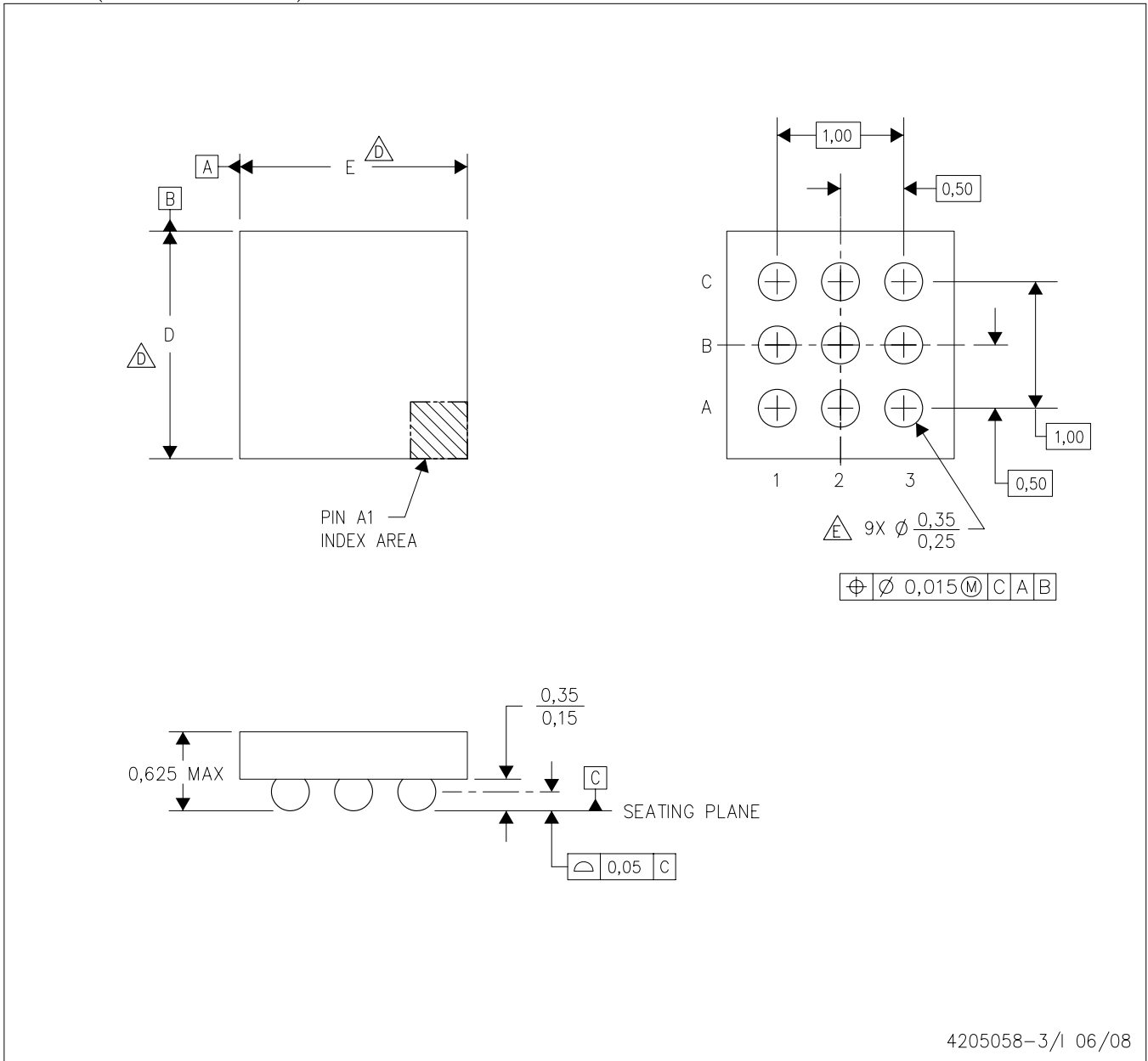



YZF (S-XBGA-N9)

DIE-SIZE BALL GRID ARRAY



4205058-3/1 06/08

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.
  -  Devices in YZF package can have dimension D ranging from 1.44 to 2.15 mm and dimension E ranging from 1.44 to 2.15 mm. To determine the exact package size of a particular device, refer to the device datasheet or contact a local TI representative.
  - E. Reference Product Data Sheet for array population. 3 x 3 matrix pattern is shown for illustration only.
  - F. This package contains lead-free balls. Refer to YEF (Drawing #4204181) for tin-lead (SnPb) balls.

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